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September 2015

### FDS89161LZ

## Dual N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100 V, 2.7 A, 105 m $\Omega$

#### Features

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)}$  = 105 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 2.7 A
- Max  $r_{DS(on)}$  = 160 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 2.1 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability in a widely used surface mount package
- CDM ESD protection level > 2KV typical (Note 4)
- 100% UIL Tested
- RoHS Compliant



#### **General Description**

This N-Channel logic Level MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resisitance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

G2

3 S2

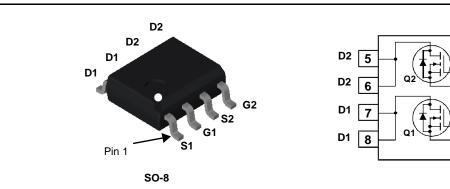
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2 G1

1 S1

#### Application

■ DC-DC conversion



#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous			2.7	•	
	-Pulsed			15	— A	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	13	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		31	w	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note1a)	1.6	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	40	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS89161LZ	FDS89161LZ	SO-8	13 "	12 mm	2500 units

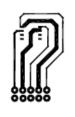
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	100			V	
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		68		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA	
On Chara	icteristics					-	
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1	1.7	2.2	V	
$\Delta V_{GS(th)}$ $\Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-6		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 2.7 \text{ A}$		81	105		
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 2.1 A		110	160 mΩ		
		$V_{GS}$ = 10 V, $I_D$ = 2.7 A, $T_J$ = 125 °C		140	182		
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \ \text{I}_{D} = 2.7 \text{ A}$		7.8		S	
	Characteristics			227	302	۶Ę	
C <sub>iss</sub>	Input Capacitance Output Capacitance	$V_{DS} = 50 V, V_{GS} = 0 V,$		44	58	pF pF	
C <sub>oss</sub> C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		3	4	pF	
R <sub>a</sub>	Gate Resistance			0.9		Ω	
9	g Characteristics						
	Turn-On Delay Time			3.8	10	ns	
t <sub>d(on)</sub> t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 2.7 A,		1.2	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		9.5	17	ns	
t <sub>f</sub>	Fall Time			1.6	10	ns	
	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		3.8	5.3	nC	
$Q_{q(TOT)}$	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V} \text{ V}_{DD} = 50 \text{ V},$		2.1	2.9	nC	
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 2.7 A		0.7		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			0.7		nC	
Drain-Sou	urce Diode Characteristics						
		$V_{GS} = 0 V, I_{S} = 2.7 A$ (Note 2)		0.8	1.3		
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.8	1.2	V	
t <sub>rr</sub>	Reverse Recovery Time			31	56	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	– I <sub>F</sub> = 2.7 A, di/dt = 100 A/μs		20	36	nC	

NOTES:

1. R<sub>0,JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

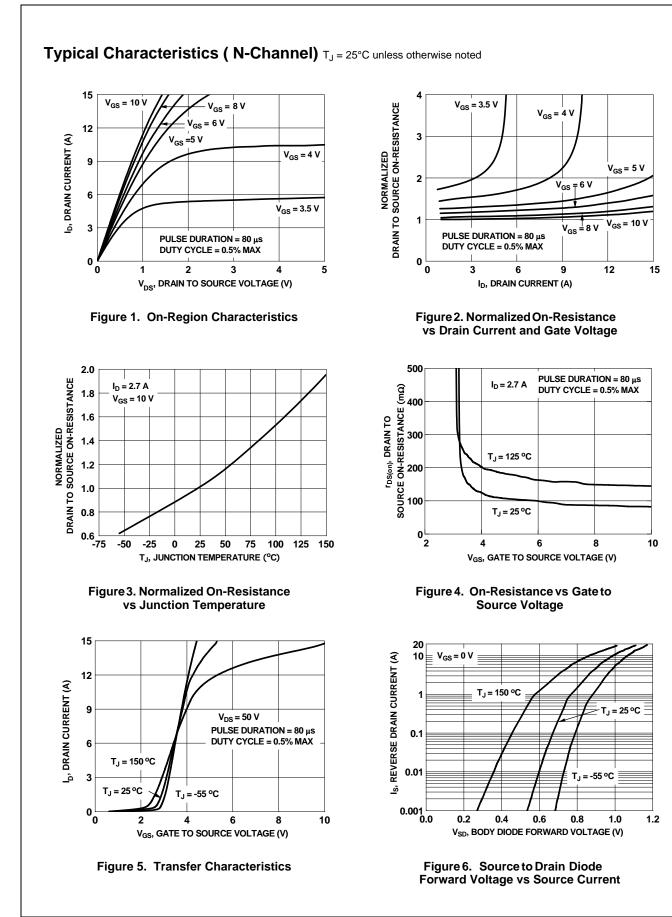






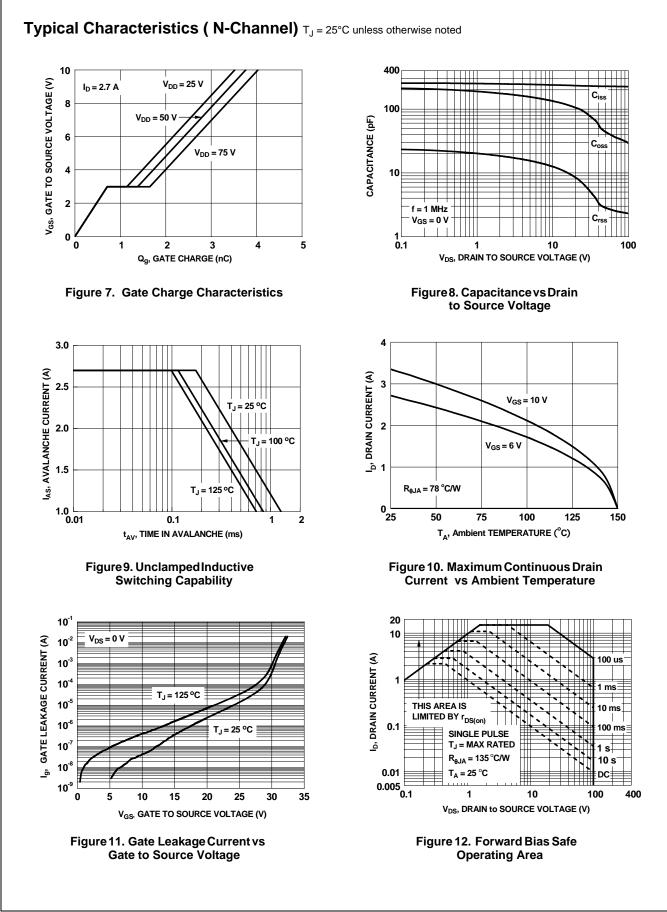
b) 135°C/W when mounted on a minimun pad

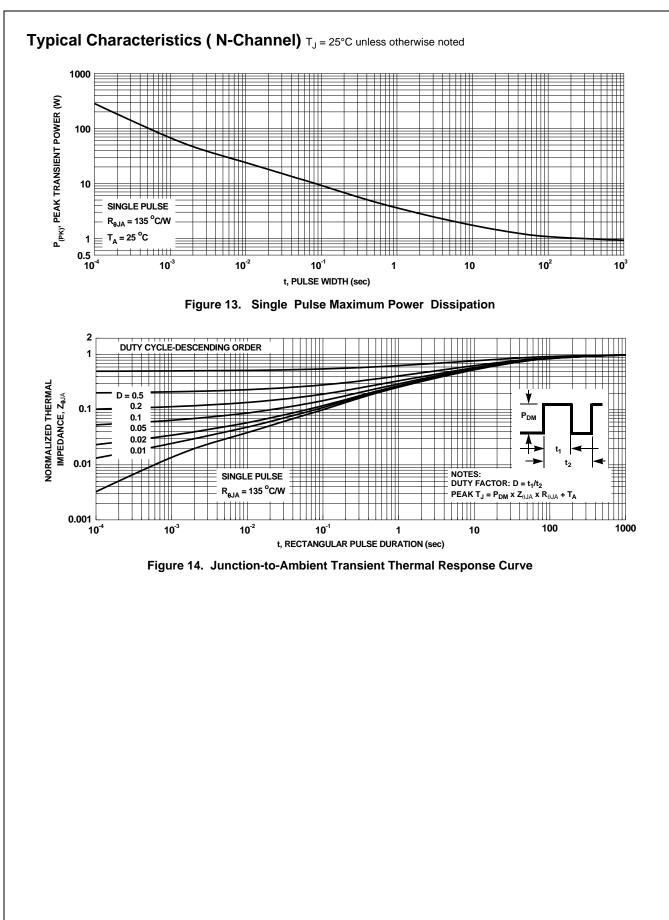
Pulse Test: Pulse Width < 300μs, Duty cycle < 2.0%.</li>
 Starting TJ = 25 °C, L = 0.3 mH, IAS =25 A, VDD = 27 V, VGS = 10V.
 The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



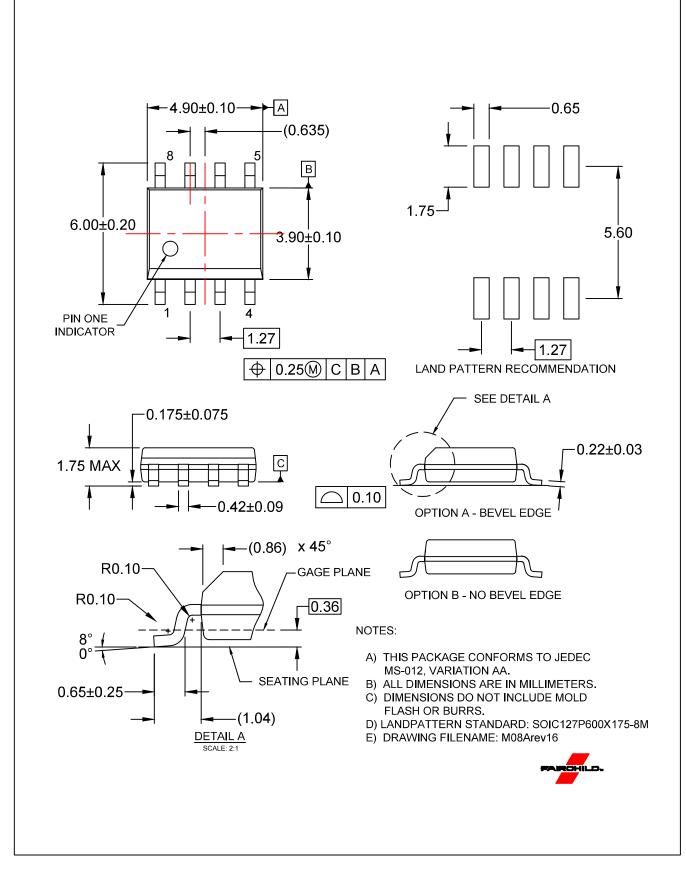
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